IGBT - Field Stop 650 V, 40 A

FGH40N65UFDTU, FGH40N65UFDTU-F085

Description

Using novel field stop IGBT technology, ON Semiconductor's field stop IGBTs offer the optimum performance for Automotive Chargers, Inverter, and other applications where low conduction and switching losses are essential.

Features

- High Current Capability
- Low Saturation Voltage: $V_{CE(sat)} = 1.8 \text{ V}$ @ $I_C = 40 \text{ A}$
- High Input Impedance
- Fast Switching
- Qualified to Automotive Requirements of AEC-Q101 (FGH40N65UFDTU-F085)
- These Devices are Pb-Free and are RoHS Compliant

Applications

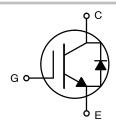
- Automotive Chargers, Converters, High Voltage Auxiliaries
- Inverters, PFC, UPS

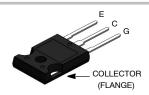


ON Semiconductor®

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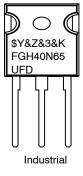
V _{CES}	I _C
650 V	40 A

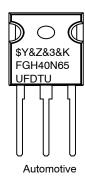




TO-247-3LD CASE 340CK

MARKING DIAGRAM





\$Y = ON Semiconductor Logo &Z = Assembly Plant Code &3 = Numeric Date Code

&K = Lot Code

FGH40N65UFD /

FGH40N65UFDTU = Specific Device Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS

Symbol	Description		Ratings	Unit
V _{CES}	Collector to Emitter Voltage		650	V
V _{GES}	Gate to Emitter Voltage		±20	V
I _C	Collector Current	Hector Current $T_C = 25^{\circ}C$ $T_C = 100^{\circ}C$		А
				Α
I _{CM} (Note 1)	Pulsed Collector Current	T _C = 25°C	120	Α
P _D	Maximum Power Dissipation	um Power Dissipation $T_C = 25^{\circ}C$		W
	T _C = 100°C		116	W
TJ	Operating Junction Temperature		-55 to +150	°C
T _{STG}	Storage Temperature Range		-55 to +150	°C
TL	Maximum Lead Temp. for Soldering Purp	ooses, 1/8" from Case for 5 Seconds	300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive rating: Pulse width limited by max. junction temperature.

THERMAL CHARACTERISTICS

Symbol	Parameter		Unit
R _{θJC} (IGBT)	Thermal Resistance, Junction to Case	0.43	°C/W
R _{θJC} (Diode)	Thermal Resistance, Junction to Case	1.45	°C/W
$R_{ heta JA}$	Thermal Resistance, Junction to Ambient	40	°C/W

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method	Qty per Tube
FGH40N65UFDTU	FGH40N65UFD	TO-247	Tube	30
FGH40N65UFDTU-F085*	FGH40N65UFDTU	TO-247	Tube	30

^{*}Qualified to Automotive Requirements of AEC-Q101.

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
FF CHARACT	TERISTICS	•	•	•		
BV _{CES}	Collector to Emitter Breakdown Voltage	$V_{GE} = 0 \text{ V}, I_{C} = 250 \mu\text{A}$	650	-	_	V
$\Delta BV_{CES} / \Delta T_{J}$	Temperature Coefficient of Breakdown Voltage	$V_{GE} = 0 \text{ V}, I_{C} = 250 \mu A$	-	0.6	-	V/°C
I _{CES}	Collector Cut-Off Current	V _{CE} = V _{CES} , V _{GE} = 0 V	-	-	250	μΑ
I _{GES}	G-E Leakage Current	V _{GE} = V _{GES} , V _{CE} = 0 V	_	-	±400	nA
N CHARACTE	ERISTICS				-	
V _{GE(th)}	G-E Threshold Voltage	$I_C = 250 \mu A, V_{CE} = V_{GE}$	4.0	5.0	6.5	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage	I _C = 40 A, V _{GE} = 15 V,	-	1.8	2.4	V
		I _C = 40 A, V _{GE} = 15 V, T _C = 125°C	_	2.0	-	٧
YNAMIC CHA	RACTERISTICS	•	•	•		•
C _{ies}	Input Capacitance	V _{CE} = 30 V, V _{GE} = 0 V,	-	1860	_	pF
C _{oes}	Output Capacitance	f = 1 MHz	_	200	_	pF
C _{res}	Reverse Transfer Capacitance	1	-	65	-	pF
WITCHING CH	HARACTERISTICS	•	•	•		•
T _{d(on)}	Turn-On Delay Time	$\begin{array}{c} V_{CC} = 400 \text{ V, } I_{C} = 40 \text{ A,} \\ R_{G} = 10 \Omega, V_{GE} = 15 \text{ V,} \\ \text{Inductive Load, } T_{C} = 25^{\circ}\text{C} \end{array}$	-	23	-	ns
T _r	Rise Time		-	35	_	ns
T _{d(off)}	Turn-Off Delay Time	1	-	126	_	ns
T _f	Fall Time		_	26	60	ns
E _{on}	Turn-On Switching Loss		_	1.28	_	mJ
E _{off}	Turn-Off Switching Loss	1	_	0.50	_	mJ
E _{ts}	Total Switching Loss		-	1.78	-	mJ
T _{d(on)}	Turn-On Delay Time	$V_{CC} = 400 \text{ V}, I_{C} = 40 \text{ A},$	-	21	_	ns
T _r	Rise Time	$R_G = 10 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 125^{\circ}C$	_	39	_	ns
T _{d(off)}	Turn-Off Delay Time	1	_	131	_	ns
T _f	Fall Time		-	72	-	ns
E _{on}	Turn-On Switching Loss		-	1.62	=	mJ
E _{off}	Turn-Off Switching Loss		-	0.79	_	mJ
E _{ts}	Total Switching Loss		-	2.41	-	mJ
Qg	Total Gate Charge	V _{CE} = 400 V, I _C = 40 A, V _{GE} = 15 V	-	119	-	nC
Q _{ge}	Gate to Emitter Charge	VGE - 10 V	-	14	-	nC
Q _{gc}	Gate to Collector Charge		-	64	-	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

ELECTRICAL CHARACTERISTICS OF THE DIODE (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions		Min	Тур	Max	Unit
V_{FM}	Diode Forward Voltage	I _F = 20 A	T _C = 25°C	-	1.80	2.6	V
			T _C = 125°C	-	1.71	-	
T _{rr}	Diode Reverse Recovery Time	$I_F = 20 \text{ A},$ $di_F/dt = 200 \text{ A}/\mu \text{s}$	T _C = 25°C	-	65	-	ns
		μι _Γ /μι – 200 Α/μι	T _C = 125°C	-	215	-	
Q _{rr}	Diode Reverse Recovery Charge]	T _C = 25°C	-	145	-	nC
			T _C = 125°C	-	775	-	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL PERFORMANCE CHARACTERISTICS

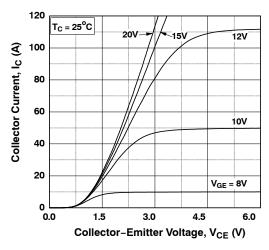


Figure 1. Typical Output Characteristics

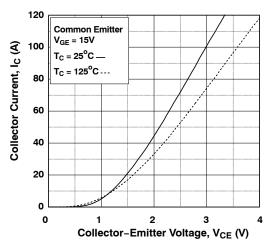


Figure 3. Typical Saturation Voltage Characteristics

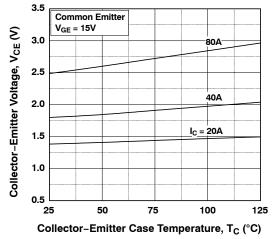


Figure 5. Saturation Voltage vs. Case Temperature at Variant Current Level

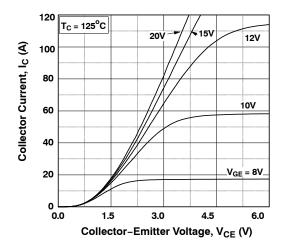


Figure 2. Typical Output Characteristics

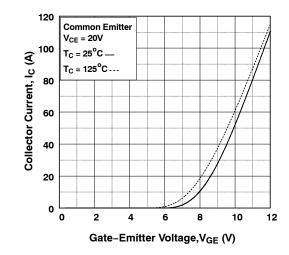


Figure 4. Transfer Characteristics

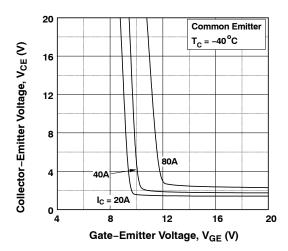


Figure 6. Saturation Voltage vs. V_{GE}

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

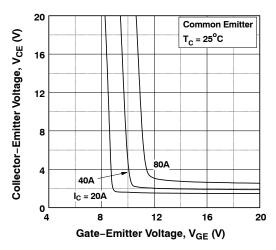


Figure 7. Saturation Voltage vs V_{GE}

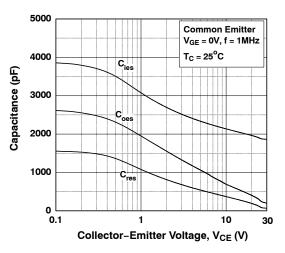


Figure 9. Capacitance Characteristics

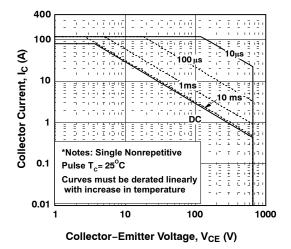


Figure 11. SOA Characteristics

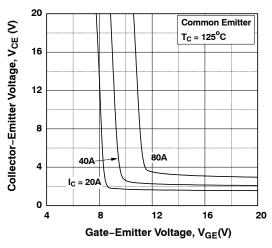


Figure 8. Saturation Voltage vs V_{GE}

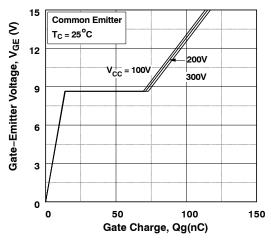


Figure 10. Gate Charge Characteristics

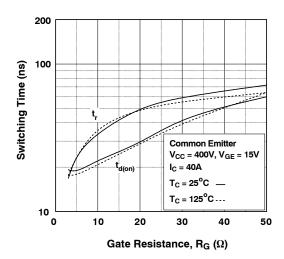


Figure 12. Turn-on Characteristics vs. Gate Resistance

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

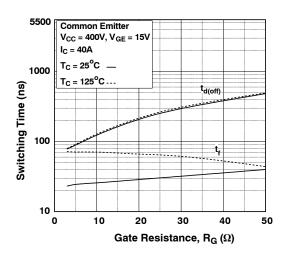


Figure 13. Turn-off Characteristics vs. Gate Resistance

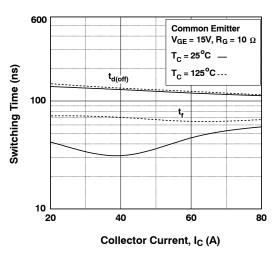


Figure 15. Turn-off Characteristics vs. Collector Current

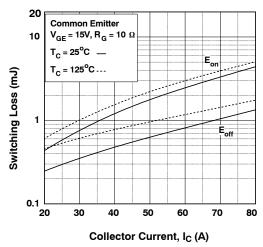


Figure 17. Switching Loss vs. Collector Current

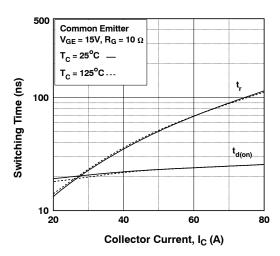


Figure 14. Turn-on Characteristics vs. Collector Current

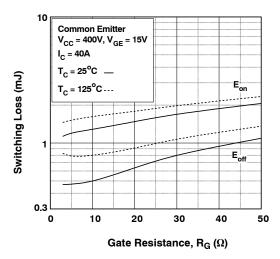
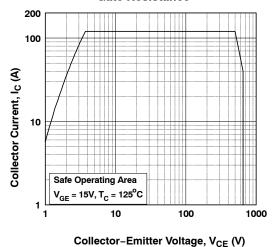


Figure 16. Switching Loss vs.
Gate Resistance



Conector-Emitter voltage, vCE (v)

Figure 18. Turn Off Switching SOA Characteristics

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

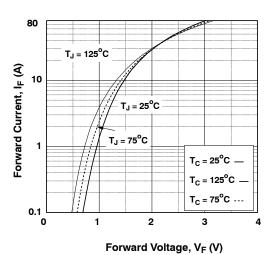


Figure 19. Forward Characteristics

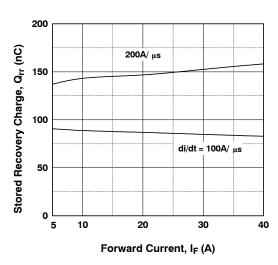


Figure 21. Stored Charge

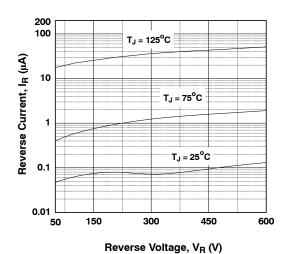


Figure 20. Reverse Current

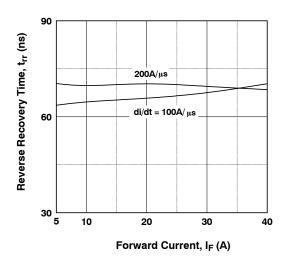


Figure 22. Reverse Recovery Time

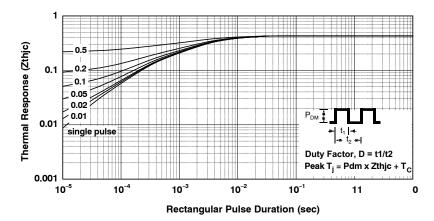
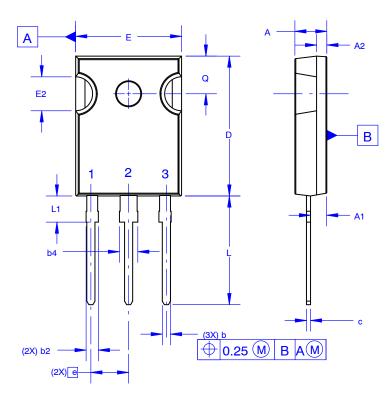


Figure 23. Transient Thermal Impedance of IGBT

TO-247-3LD SHORT LEAD

CASE 340CK ISSUE A



NOTES: UNLESS OTHERWISE SPECIFIED.

- A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DRAWING CONFORMS TO ASME Y14.5 2009.
- D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
- E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.

GENERIC MARKING DIAGRAM*



XXXX = Specific Device Code

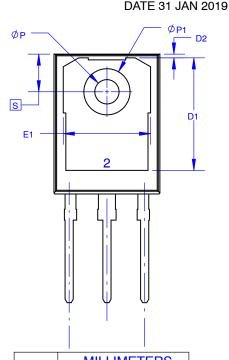
A = Assembly Location

Y = Year

WW = Work Week

ZZ = Assembly Lot Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.



DIM	MILLIMETERS			
DIIVI	MIN	NOM	MAX	
Α	4.58	4.70	4.82	
A1	2.20	2.40	2.60	
A2	1.40	1.50	1.60	
b	1.17	1.26	1.35	
b2	1.53	1.65	1.77	
b4	2.42	2.54	2.66	
С	0.51	0.61	0.71	
D	20.32	20.57	20.82	
D1	13.08	~	~	
D2	0.51	0.93	1.35	
E	15.37	15.62	15.87	
E1	12.81	~	~	
E2	4.96	5.08	5.20	
е	~	5.56	~	
L	15.75	16.00	16.25	
L1	3.69	3.81	3.93	
ØΡ	3.51	3.58	3.65	
Ø P1	6.60	6.80	7.00	
Q	5.34	5.46	5.58	
S	5.34	5.46	5.58	

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DESCRIPTION:	TO-247-3LD SHORT LEAD		PAGE 1 OF 1	

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